# imall

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#### 20V N-Channel PowerTrench® MOSFET

#### **General Description**

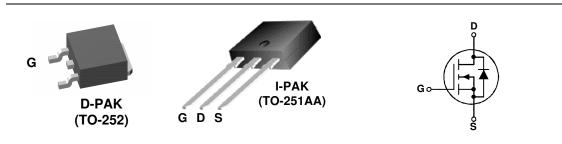
This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low  $R_{DS(ON)}$ , fast switching speed and extremely low  $R_{DS(ON)}$  in a small package.

#### Applications

- DC/DC converter
- Motor Drives

#### Features

- Low gate charge (16 nC)
- Fast Switching
- High performance trench technology for extremely low  $R_{\text{DS}(\text{ON})}$



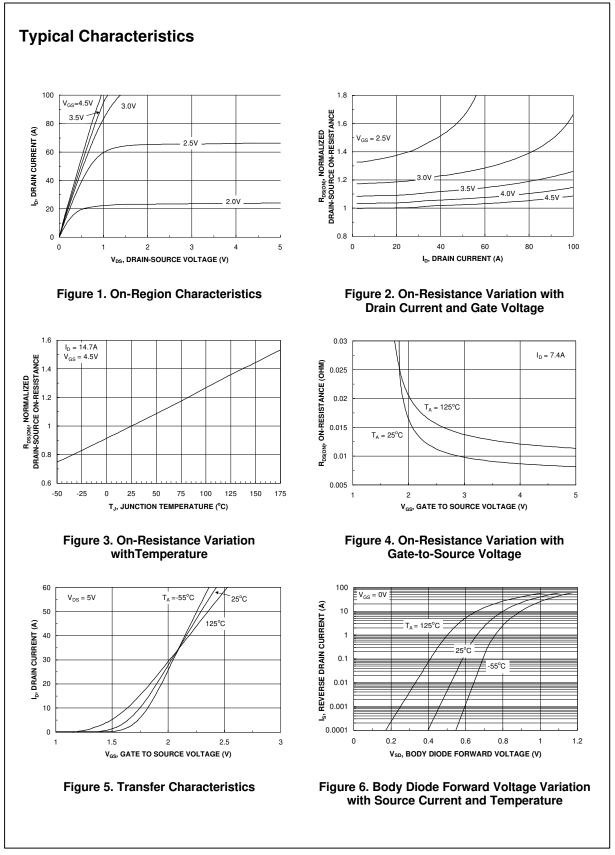
#### Absolute Maximum Ratings TA=25°C unless otherwise noted

Symbol	Parameter					F		Units	
V <sub>DSS</sub>	Drain-Source Voltage					20			V
V <sub>GSS</sub>	Gate-Source Voltage					± 12			V
I <sub>D</sub> Continuous Drain Current @T <sub>C</sub> =25°C (No				(Note 3)		50		А	
			@T <sub>A</sub> =25	°C	(Note 1a)		14.7		
			Pulsed		(Note 1a)		60		
PD	Power Diss	ipation	@T <sub>C</sub> =25	°C	(Note 3)		44		W
			@T <sub>A</sub> =25	°C	(Note 1a)		3.8		
			@T <sub>A</sub> =25	°C	(Note 1b)		1.6		
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range				-55 to +175			°C	
Therma	l Charac	teristics							
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case (Note 1)				3.4			°C/W	
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient (Note 1a)					45			°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient (Note 1b)				96			°C/W	
Packag	e Markin	g and Or	dering	Infor	mation	1			
Device Marking		Device	Device		kage	Reel Size	Tape width	Qu	antity
FDD	3706	FDD370	3706 D-PAK		TO-252)	13"	16mm	250	0 units
FDU3706		FDU370	06	I-PAK (	TO-251)	Tube	N/A		75

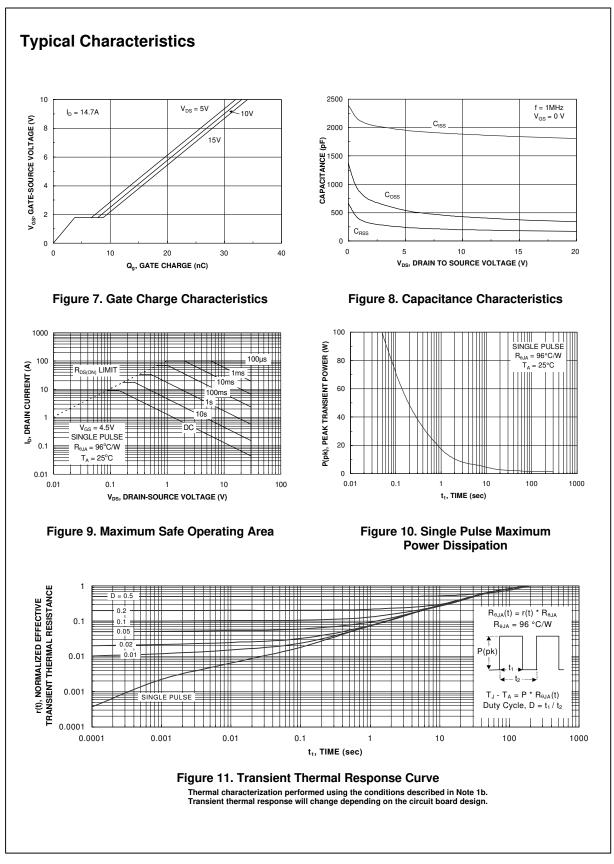
# FDD3706/FDU3706

March 2015

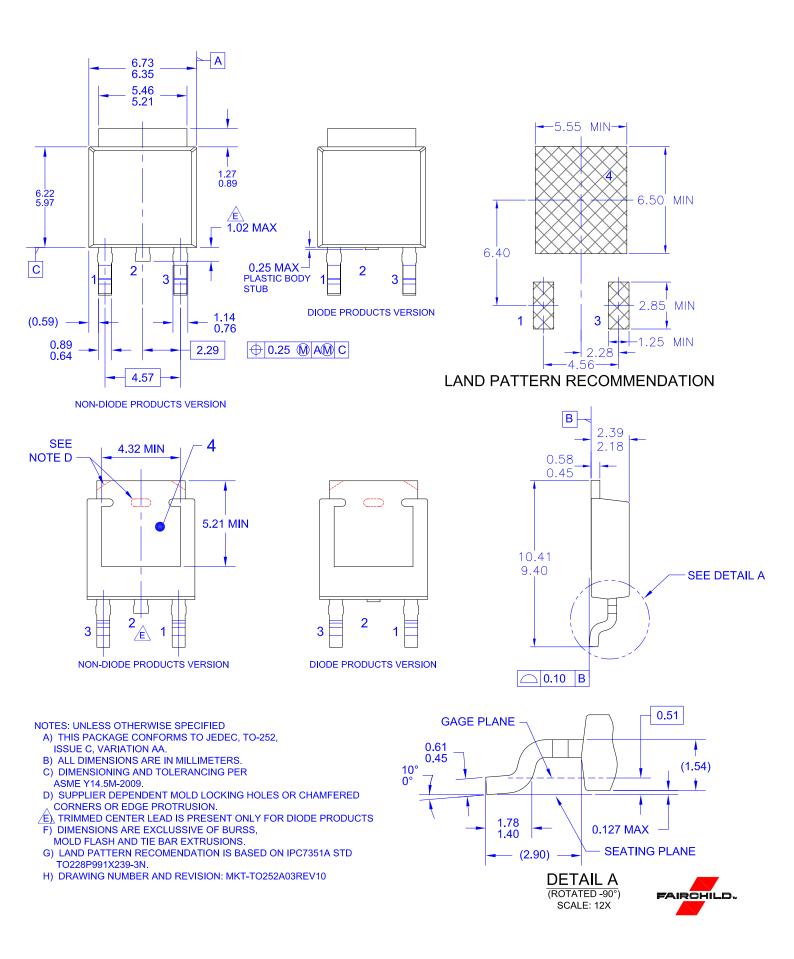
Alanche Ratings (Not rce Avalanche Energy rce Avalanche Current CS urce Breakdown Voltage n Voltage Temperature t Voltage Drain Current y Leakage, Forward y Leakage, Reverse CS (Note 2) shold Voltage	e 2) Single Pulse, $V_{DD} = 10V$ , $I_D = 7A$ $V_{GS} = 0 V$ , $I_D = 250 \mu A$ $I_D = 250 \mu A$ , Referenced to $25^{\circ}C$ $V_{DS} = 16 V$ , $V_{GS} = 0 V$ $V_{GS} = 12 V$ , $V_{DS} = 0 V$ $V_{GS} = -12 V$ , $V_{DS} = 0 V$	20	13	60 7 1	mJ A V mV/°C μA
rce Avalanche Energy rce Avalanche Current CS urce Breakdown Voltage n Voltage Temperature t Voltage Drain Current y Leakage, Forward y Leakage, Reverse CS (Note 2)	$\label{eq:VGS} \begin{array}{l} \mbox{Single Pulse, } V_{DD} = 10V, \ I_{D} = 7A \\ \hline \\ V_{GS} = 0 \ V, & I_{D} = 250 \ \mu A \\ I_{D} = 250 \ \mu A, \mbox{Referenced to } 25^{\circ}\mbox{C} \\ \hline \\ V_{DS} = 16 \ V, & V_{GS} = 0 \ V \\ \hline \\ V_{GS} = 12 \ V, & V_{DS} = 0 \ V \\ \end{array}$	20	13	7	A V mV/°C
rce Avalanche Current CS Irrce Breakdown Voltage In Voltage Temperature t Voltage Drain Current y Leakage, Forward y Leakage, Reverse CS (Note 2)	$\begin{split} V_{GS} &= 0 \ V, & I_D = 250 \ \mu A \\ I_D &= 250 \ \mu A, \text{Referenced to} \ 25^\circ\text{C} \\ V_{DS} &= 16 \ V, & V_{GS} = 0 \ V \\ V_{GS} &= 12 \ V, & V_{DS} = 0 \ V \end{split}$	20	13	1	A V mV/°C
rrce Breakdown Voltage n Voltage Temperature t Voltage Drain Current y Leakage, Forward y Leakage, Reverse (Note 2)	$\begin{split} I_D &= 250 \; \mu \text{A}, \text{Referenced to } 25^\circ\text{C} \\ V_{DS} &= 16 \; \text{V}, \qquad V_{GS} &= 0 \; \text{V} \\ V_{GS} &= 12 \; \text{V}, \qquad V_{DS} &= 0 \; \text{V} \end{split}$	20	13		mV/°C
rrce Breakdown Voltage n Voltage Temperature t Voltage Drain Current y Leakage, Forward y Leakage, Reverse (Note 2)	$\begin{split} I_D &= 250 \; \mu \text{A}, \text{Referenced to } 25^\circ\text{C} \\ V_{DS} &= 16 \; \text{V}, \qquad V_{GS} &= 0 \; \text{V} \\ V_{GS} &= 12 \; \text{V}, \qquad V_{DS} &= 0 \; \text{V} \end{split}$	20	13		mV/°C
n Voltage Temperature t Voltage Drain Current y Leakage, Forward y Leakage, Reverse (Note 2)	$\begin{split} I_D &= 250 \; \mu \text{A}, \text{Referenced to } 25^\circ\text{C} \\ V_{DS} &= 16 \; \text{V}, \qquad V_{GS} &= 0 \; \text{V} \\ V_{GS} &= 12 \; \text{V}, \qquad V_{DS} &= 0 \; \text{V} \end{split}$		13		
y Leakage, Forward y Leakage, Reverse CS (Note 2)	$V_{GS} = 12 \text{ V}, \qquad V_{DS} = 0 \text{ V}$				μA
y Leakage, Reverse					
CS (Note 2)	$V_{GS} = -12 \text{ V} \qquad V_{DS} = 0 \text{ V}$			100	nA
				-100	nA
<u> </u>	$V_{DS} = V_{GS}, \qquad I_D = 250 \ \mu A$	0.5	1	1.5	V
shold Voltage ure Coefficient	$I_D = 250 \ \mu$ A,Referenced to 25°C		-3.5	-	mV/°C
n–Source ance	$ \begin{array}{ll} V_{GS} = 10 \ V, & I_D = 16.2 \ A \\ V_{GS} = 4.5 \ V, & I_D = 14.7 \ A \\ V_{GS} = 2.5 \ V, & I_D = 12.2 \ A \\ V_{GS} = 4.5 \ V, \ I_D = 14.7 \ A, T_J = 125^\circ C \end{array} $		7.5 8 11 12.6	9 11 16 19	mΩ
Drain Current	$V_{GS}=4.5~V, \qquad V_{DS}=5~V$	30			Α
ransconductance	$V_{DS} = 5 V$ , $I_D = 14.7 A$		65		S
eristics					
			1882		pF
pacitance			430		pF
ransfer Capacitance	T = 1.0 MHZ		201		pF
cteristics (Note 2)					
			11	20	ns
Rise Time	$V_{DD} = 10 V, I_D = 1 A,$		15	27	ns
Delay Time	$V_{GS} = 4.5 \text{ V}, \qquad R_{GEN} = 6 \Omega$		35	56	ns
Fall Time			16	29	ns
Charge			16	23	nC
rce Charge	50 , 5		3.7		nC
n Charge	VGS - 7.0 V		4		nC
ode Characteristics	and Maximum Ratings				
				3.2	Α
rce Diode Forward Volta	ge $V_{GS} = 0 V$ , $I_S = 3.2 A$ (Note 2)		0.7	1.2	V
	Continuous Drain–Sourc Irce Diode Forward Voltag to-case and case-to-ambient ther	$V_{GS} = 2.5 \text{ V},  I_D = 12.2 \text{ A}$ $V_{GS} = 4.5 \text{ V},  I_D = 14.7 \text{ A}, \text{T}_J = 125^{\circ}\text{C}$ Drain Current $V_{GS} = 4.5 \text{ V},  V_{DS} = 5 \text{ V}$ ransconductance $V_{DS} = 5 \text{ V},  I_D = 14.7 \text{ A}$ <b>teristics</b> acitance pacitance $V_{DS} = 10 \text{ V},  V_{GS} = 0 \text{ V},  f = 1.0 \text{ MHz}$ <b>teristics</b> (Note 2) Delay Time Rise Time $V_{DS} = 10 \text{ V},  I_D = 1 \text{ A},  V_{GS} = 4.5 \text{ V},  R_{GEN} = 6 \Omega$ Fall Time $V_{DS} = 10 \text{ V},  I_D = 14.7 \text{ A},  V_{GS} = 4.5 \text{ V},  R_{GEN} = 6 \Omega$ <b>teristics</b> (Note 2) Delay Time $V_{DS} = 10 \text{ V},  I_D = 1 \text{ A},  V_{GS} = 4.5 \text{ V},  R_{GEN} = 6 \Omega$ Fall Time $V_{DS} = 10 \text{ V},  I_D = 14.7 \text{ A},  V_{GS} = 4.5 \text{ V}$ in Charge $V_{DS} = 10 \text{ V},  I_D = 14.7 \text{ A},  V_{GS} = 4.5 \text{ V}$ The continuous Drain–Source Diode Forward Current The Diode Forward Voltage $V_{GS} = 0 \text{ V},  I_S = 3.2 \text{ A}  (Note 2)$	VGS = 2.5 V, ID = 12.2 A VGS = 4.5 V, ID = 14.7 A, TJ = 125°CDrain CurrentVGS = 4.5 V, VDS = 5 VOransconductanceVDS = 5 V, ID = 14.7 Ateristicsacitance pacitanceVDS = 10 V, VGS = 0 V, ID = 14.7 Ateristicsacitance pacitanceVDS = 10 V, VGS = 0 V, ID = 14.7 Ateristics (Note 2)Delay TimeDelay TimeRise Time OPLATIMEVDS = 10 V, VDD = 10 V, ID = 1 A, VGS = 4.5 V, RGEN = 6 \OmegaTime ChargeVDS = 10V, VDS = 10V, VGS = 4.5 V, RGEN = 6 \OmegaTochargeVDS = 10V, VGS = 4.5 V, VGS = 4.5 V, VGS = 4.5 VTochargeDelay TimeContinuous Drain-Source Diode Forward Current urce Diode Forward VoltageVGS = 0 V, IS = 3.2 A (Note 2)to-case and case-to-ambient thermal resistance where the case thermal reference is defined a	VGS = 2.5 V, ID = 12.2 A11VGS = 4.5 V, ID = 14.7 A, TJ = 125°C11Drain CurrentVGS = 4.5 V, VDS = 5 V30ransconductanceVDS = 5 V, ID = 14.7 A65teristicsacitancepacitanceVDS = 10 V, VGS = 0 V, ID = 14.7 ApacitanceF = 1.0 MHz1882pacitanceVDS = 10 V, VGS = 0 V, ID = 14.7 A430transfer CapacitanceVDS = 10 V, ID = 1 A, VGS = 0 V, ID = 10 V, ID = 1 A, VGS = 4.5 V, RGEN = 6 \Omega11Delay TimeVDD = 10 V, ID = 1 A, VGS = 4.5 V, RGEN = 6 \Omega35Fall TimeVDS = 10V, VGS = 4.5 V, ID = 14.7 A, ID = 14.	VGS = 2.5 V, ID = 12.2 A VGS = 4.5 V, ID = 14.7 A, TJ = 125°C111612.619Drain CurrentVGS = 4.5 V, VDS = 5 V30TransconductanceVDS = 5 V, ID = 14.7 A65transconductanceVDS = 5 V, ID = 14.7 A65teristicsacitancepacitanceVDS = 10 V, VGS = 0 V, f = 1.0 MHztransfer Capacitance1882Cteristics (Note 2)201Delay Time11Rise TimeVDD = 10 V, ID = 1 A, VGS = 6 DDelay Time16Fall Time16CochargeVDS = 10V, VGS = 4.5 V, RGEN = 6 DOchargeVDS = 10V, VGS = 4.5 V, RGEN = 6 DChargeVDS = 10V, VGS = 4.5 V, VGS = 0.5 V, VGS = 0

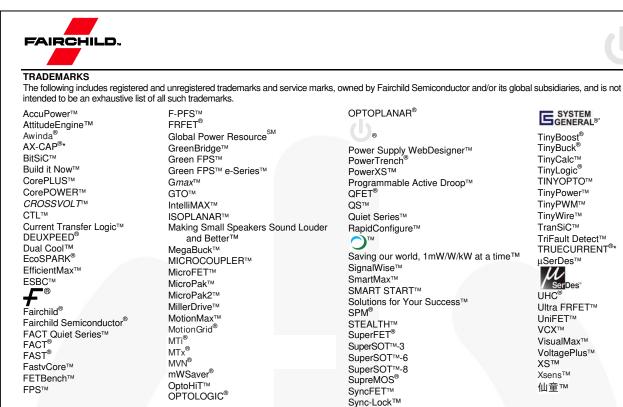


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